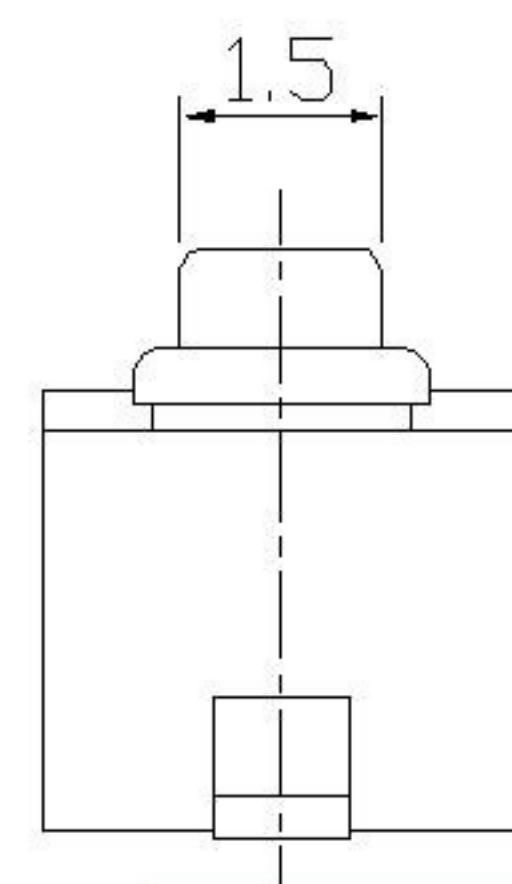
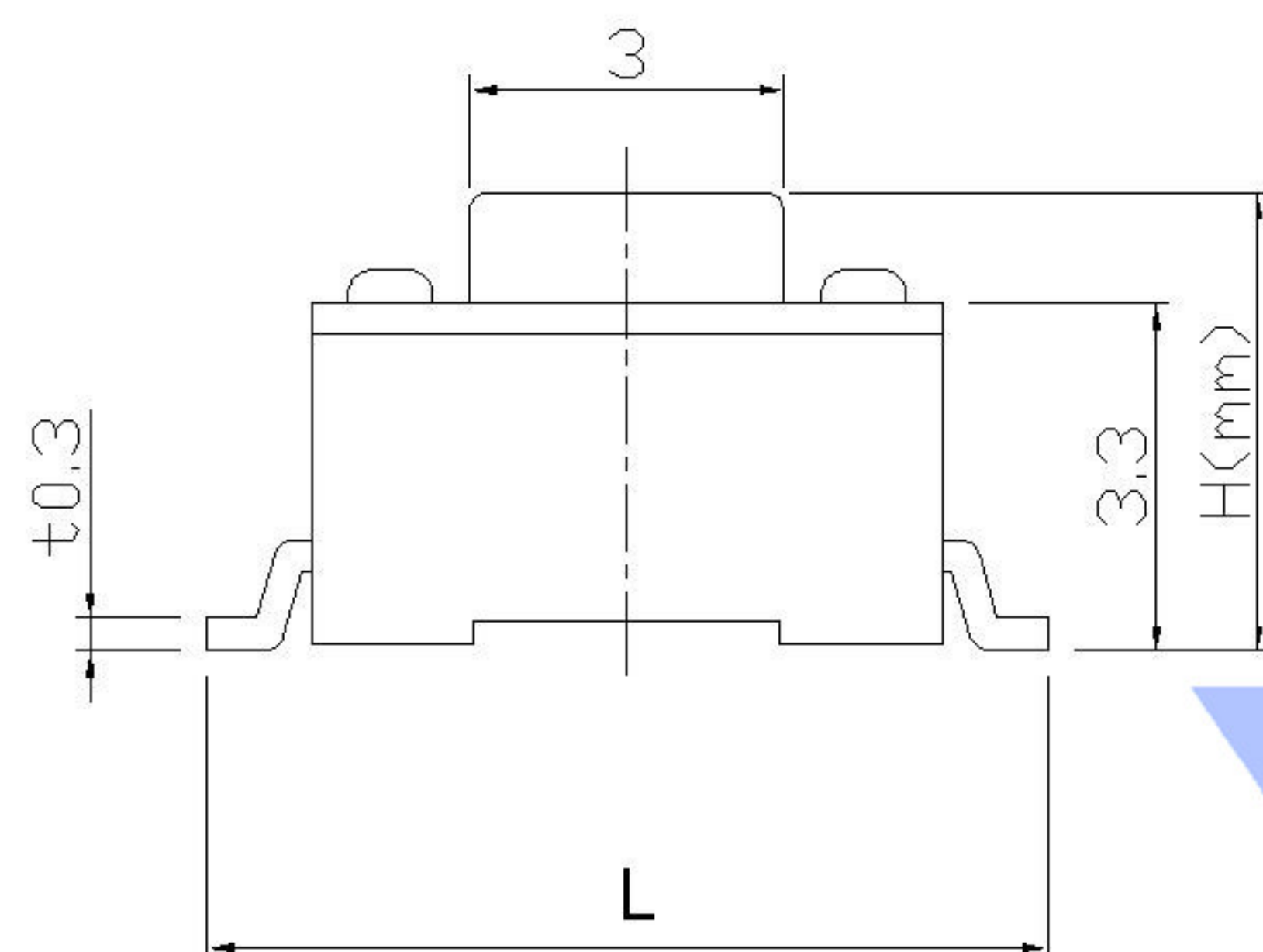




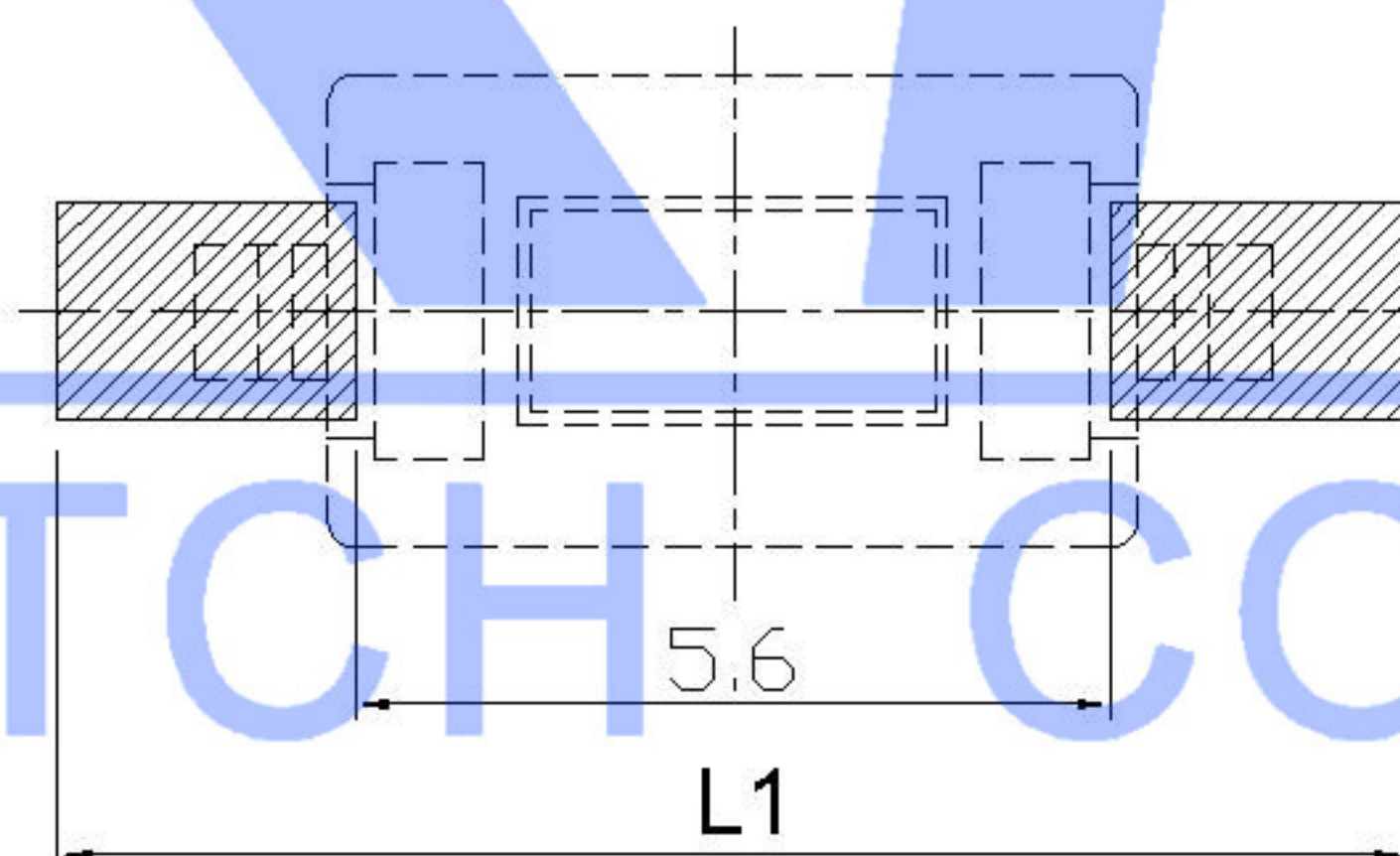
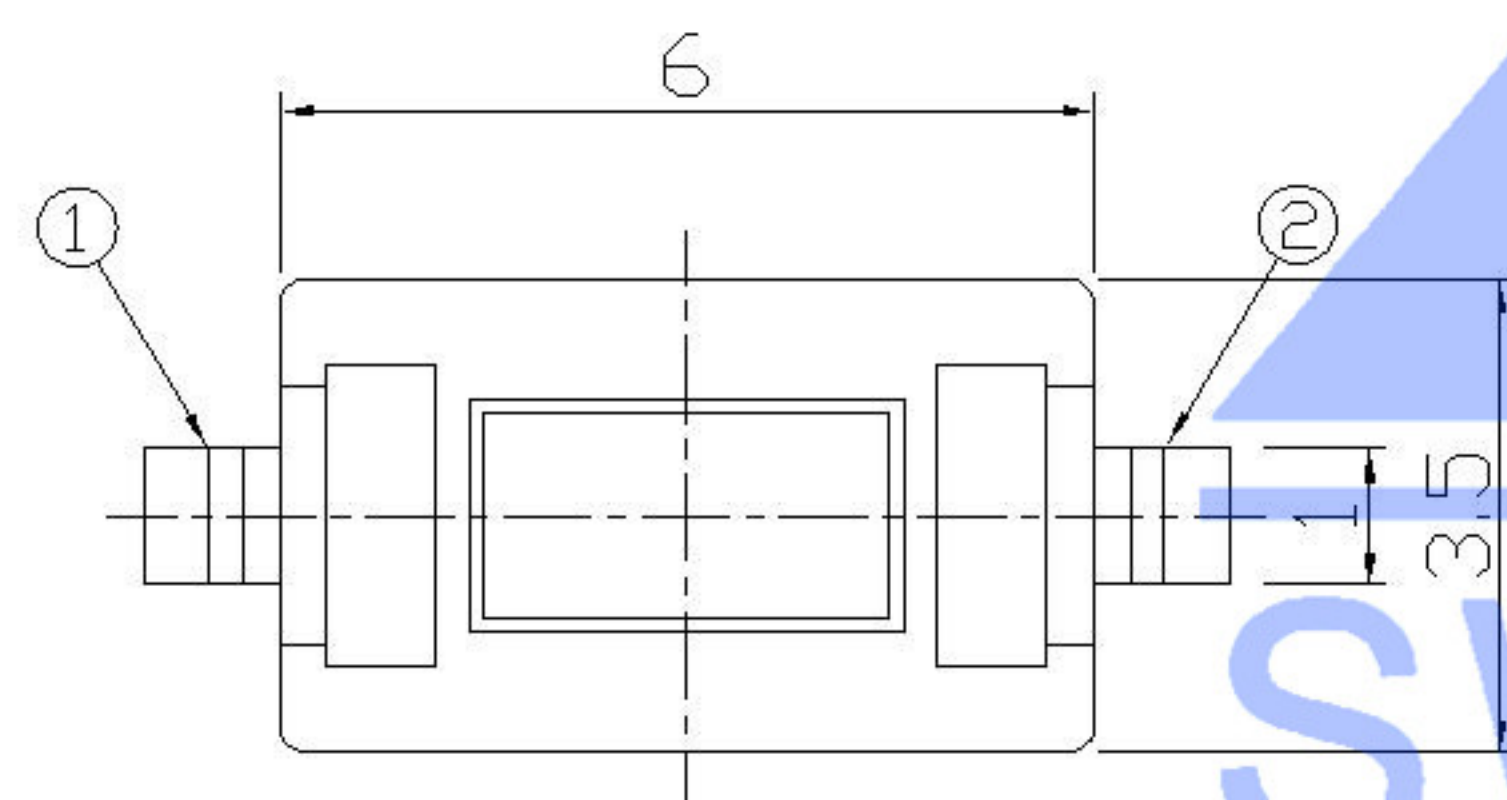
CIRCUIT DIAGRAM

P	L	L1
A	8.0	10

SPECIFICATION

Contact Rating:	50mA,12V DC
Contact Resistance:	100mΩ max
Insulation Resistance:	100mΩ min.500V DC
Dielectric Strength:	250V AC/1minute
Travel:	0.25mm
Operating Temp:	-20℃~+70℃
Storage Temp:	-30℃~+80℃

P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering



PAPT NO	TS-1101S-X-X-B-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	H:A:4.3 B:5.0 C:6.0 D:7.0
Fixed column	A:With B:without
color	B:black W:white
Pin pitch	P

⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Lcp		—
②	Cover	—	1	Spcc	Plating Nickel	—
①	Keystake	—	1	Pa46		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

						DSND		DATE		SCALE: N/A	MODEL TYPE: TACT SWITCH				
					units: mm	DWN		DATE		VIEW: 	PART NO.:				
△X					tolerance:										
△X					X.X	±0.2mm	CHKD		DATE		UNIT: mm	DWG NO.:			
△X					X.XX	±0.1mm						TS-1101S-X-X-B-X-X			
MARK	DESCRIPTION		DATE	REVISED	APPROVED	X.XXX	±0.05mm	APPD		DATE		SIZE: A4			
REVISIONS						UNSPECIFIED TOLERANCES		XKB INDUSTRIAL PRECISION CO.,LIMITED				WEIGHT	SHEET	REVISION	
www.xk-dg.cn www.helloxkb.com www.helloxkb.cn												1.0g	1/1	A0	